1. MATERIAL HOUSING—HIGH TEMPERATURE NYLON, BLACK, IR COMPATIBLE, UL 94V-0
   TERMINALS - 0.33 (0.013) THICK PHOS BRONZE PLATED WITH 1.27μm (0.000050) MINIMUM THICKNESS HARD GOLD IN LOCALIZED AREA AND 3.61μm (0.000150) MINIMUM THICKNESS MATTE TIN IN SOLDER AREA OVER 1.27μm (0.000050) MINIMUM THICKNESS NICKEL UNDERPLATE.

   JACK CAVITY CONFORMS TO FFC RULES AND REGULATIONS, PART 6B SUBPART F.

   CAUTION: CATEGORY 5 J ack solder tail positions do not follow same number sequence as that of traditional jacks.

   USE #30 DRILL BIT OR 3.25mm DRILL BIT WHEN PRODUCING THESE PCB HOLES.

SUGGESTED PANEL CUTOUT

SUGGESTED PCB BOARD LAYOUT
COMPONENT SIDE

TRADITIONAL JACK CATEGORY 5 JACK

PART NO.
S358341-1

TE Connectivity

MODULAR JACK ASSEMBLY
8 POSITION, HIGH DAMP LOW PROFILE CATEGORY 5